ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® MALECTRONICS INDUSTRIES®	ockburn, Illinois, A	All rights reserved un ntions.	nder both le	his docume evel parts, t	ent is a declaration the declaration en	on of the substan	ces within the manufactur ower level materials for w	rer listed ite which the m	em. Note: if anufacturer	the item is an as has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Inform					g Informatio	on		
Supplier Information												
mpany name* Company unique ID				Unique ID Authority				Response Date*				
onsemi	ni								2023-06-08			
Contact Name	Title - Contact			]	Phone - Contact*			Email - Contact*				
Product-Env-Stewards	t-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr	tem Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		Veight*	UOM	Unit Type	
FS71	40-02G-XTD	0-02G-XTD FS7140-02G CLOCH			2023-06-08		PHG	1	49.22	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	I Terminal Base Alloy J-		-STD-020 MSL F	Rating	Peak Process Body Temperature N		ature Max Time at Peak	Temperatu	ire Numbe	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy 2					260	С	30	second	ls 3			
Comments												
ATTENTION: MSL 2 Rated item requires Dry Pac	k (after electrica	l test)										
For more information regarding material composit	ion please refer to	o page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).								
Iomogeneous Material Weight Unit of Measure		Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	7.55	mg	Supplier	Silicon (Si)	7440-21-3		7.55	mg
Die Attach	2.59	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.5957	mg
			Supplier	Silver (Ag)	7440-22-4		1.9943	mg
Lead Frame	42.6	mg	Supplier	Zinc (Zn)	7440-66-6		0.0426	mg
			Supplier	Iron (Fe)	7439-89-6		0.9798	mg
			Supplier	Copper (Cu)	7440-50-8		41.535	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0426	mg
Mold Compound-Black	94.53	mg		Epoxy Phenol Resin	proprietary data		9.9256	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		84.6043	mg
Plating	1.65	mg	Supplier	Tin (Sn)	7440-31-5		1.65	mg
Wire Bond - Au	0.3	mg	Supplier	Gold (Au)	7440-57-5		0.3	mg